

04-29-1999

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Patent and Trademark Office



101022392

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

(a) Lee, Cheol-kyu

(b)

(c)

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.

Internal Address: _____

Street Address: 416, Maetan-dong, Palda-gu, Suwon-city, Kyungki-do, Republic of Korea

City _____ State _____ ZIP _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____

Execution Date: April 19, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: April 19, 1999

A. Patent Application No.(s) -

Title: Surface Wave Coupled Plasma Etching Apparatus

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David T. Millers

Internal Address: SKJERVEN, MORRILL, MacPHERSON,

FRANKLIN & FRIEL LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA ZIP 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

☒ Authorized to be charged to Deposit Account 19-2386☒ Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David T. Millers

37 396

Name of Person Signing

David Millers

Signature

4-20-99

Date

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TO: 408 453 7979
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PAGE: 04
PAGE: 02
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Att. Docket No.: AB-718 US

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, Lee, Cheol-kyu of 103-303, Byucksan Apt. 832, Jukjeon-ri, Sajeong, Yongin-city, Kyungki-do, Republic of Korea, hereby sell, assign and transfer to Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea, its successors and assigns, the entire right, title and interest throughout the world in my invention in

Surface Wave Coupled Plasma Etching Apparatus

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 19 day of April, 1999.

Cheol-kyu Lee

Cheol-kyu Lee

WITNESSED:

Signature _____

Date _____

Type or print name of witness _____

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